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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: K. TAKAI, et al.
Serial No: 10/506,529
371(c) Date: JANUARY 31, 2005
For: RESIN COATED METAL FOIL, METAL CLAD LAMINATE,
PRINTED WIRING BOARD USING THEM, AND
MANUFACTURING METHOD THEREOF
Group AU: 1794
Examiner: Cathy Fong Fong Lam
Confirm. No: 1181

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR 1.97 AND 1.98**

Mail Stop: AMEND – NO FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

July 28, 2008

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find copies of four (4) Official Actions, each issued on April 28, 2008, each in connection with a counterpart Korean application, together with partial English translations thereof. Also enclosed are copies of the following documents cited in these enclosed Official Actions, together with English-language abstracts of Japanese Patent Documents corresponding to these cited Korean patent documents:

1. Korean Patent Document No. 2000-47764;
2. Korean Patent Document No. 1998-71471; and
3. Japanese Patent Document No. 2001-80264.

JP No. 12-286531 and JP No. 2000-269637, also cited in the enclosed Official Action, have previously been submitted for consideration by the Examiner in

the above-identified application, respectively in the Information Disclosure Statement submitted September 3, 2004, upon originally filing the above-identified application, and in the Information Disclosure Statement submitted March 19, 2007.

Also enclosed is a Form PTO/SB/08A, listing the enclosed documents.

This Information Disclosure Statement is being submitted subsequent to a first Office Action on the merits in the above-identified application, in an application which is not under a Final rejection and in which a Notice of Allowance is not pending, and in which no other action closing prosecution on the merits is pending. For satisfying requirements of 37 CFR 1.97(c), the following Statement under 37 CFR 1.97(e) is made:

Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

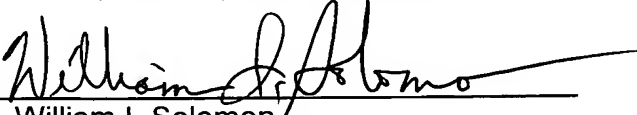
To the extent that the enclosed documents are not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied by the enclosed partial English translations of the enclosed Official Actions, and/or by English-language abstracts of Japanese patent documents corresponding to the cited Korean patent documents.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with each of the documents listed on the enclosed Form. Accordingly, consideration of the listed documents, upon further examination of the above-identified application, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case No. 1204.44255X00), or credit any excess fees to such Deposit Account.

Respectfully submitted,

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